

## APPLICATION DATA SHEET

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*Applicant Information:*Inventor 1:

Applicant Authority Type:	Inventor
Citizenship:	DE
Given Name:	Andreas
Family Name:	LINDEMANN
City of Residence:	Lampertheim
Country of Residence:	DE
Address-1 of Mailing Address:	Martin-Karcher Strasse 30
Address-2 of Mailing Address:	
City of Mailing Address:	Lampertheim
State of Mailing Address:	
Postal Code of Mailing Address:	68623
Country of Mailing Address:	DE
Phone:	
Fax:	
E-mail:	

*Correspondence Information:*

Customer Number:	23405	*23405*
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*Application Information:*

Title of Invention:           ENCAPSULATED POWER SEMICONDUCTOR ASSEMBLY  
Application Type:           regular, utility  
Attorney Docket Number: 1477.021

## Botanic Information:

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*Representative Information:*

practitioner(s) at Customer Number:

23405

\*23405\*

as my attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

*Domestic Priority Information:*

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*Assignee Information:*

Assignee 1:

Organization Name: IXYS SEMICONDUCTOR GMBH

Address-1 of Mailing Address: Edisonstrasse 15

Address-2 of Mailing Address:

City of Mailing Address: Lampertheim

State of Mailing Address:

Postal Code of Mailing Address: 68623

Country of Mailing Address: DE

Phone:

Fax:

E-mail: